

FEATURES

Extremely low harmonic distortion

- 100 dBc SFDR @ 10 MHz
- 81 dBc SFDR @ 70 MHz
- 72 dBc SFDR @ 100 MHz

Low input voltage noise: 2.2 nV/ $\sqrt{\text{Hz}}$

High speed

- 3 dB bandwidth of 1.6 GHz, $G = 1$
- Slew rate: 5000 V/ μs
- 0.1 dB gain flatness to 125 MHz
- Fast settling to 0.01% in 8 ns
- Fast overdrive recovery of 4 ns

1 mV typical offset voltage

Externally adjustable gain

Differential to differential or single-ended to differential operation

Adjustable output common-mode voltage

Single supply operation: +3.3 V to +5 V

Pb-free 3 mm x 3 mm LFCSP package

APPLICATIONS

ADC drivers

Single-ended-to-differential converters

IF and baseband gain blocks

Differential buffers

Line drivers

GENERAL DESCRIPTION

The ADA4937-1 is a low noise, ultra-low distortion, high speed differential amplifier. It is an ideal choice for driving high performance ADCs with resolutions up to 16 bits from dc to 100 MHz. The adjustable level of the output common mode allows the ADA4937-1 to match the input of the ADC. The internal common mode feedback loop also provides exceptional output balance as well as suppression of even-order harmonic distortion products.

Full differential and single-ended to differential gain configurations are easily realized with the ADA4937-1. A

FUNCTIONAL BLOCK DIAGRAM

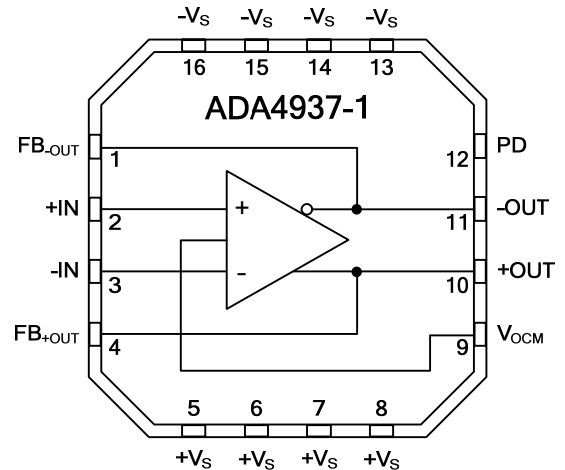


Figure 1.

simple external feedback network of four resistors determines the amplifier's closed-loop gain.

The ADA4937-1 is fabricated using ADI's proprietary third generation XFCB process, enabling it to achieve very low levels of distortion with input voltage noise of only 2.2 nV/ $\sqrt{\text{Hz}}$. The low dc offset and excellent dynamic performance of the ADA4937-1 make it well suited for a wide variety of data acquisition and signal processing and applications.

The ADA4937-1 is available in a Pb-free, 3 mm x 3mm lead frame chip scale package (LFCSP). It is specified to operate over the temperature range of -40°C to $+105^{\circ}\text{C}$.

Rev. PrA

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REVISION HISTORY

12/06—Revision PrA: Initial Version

SPECIFICATIONS

5 V OPERATION

At 25°C, $+V_S = 5\text{ V}$, $-V_S = 0\text{ V}$, $V_{OCM} = 2.5\text{ V}$, $R_G = R_F = 200\ \Omega$, $G = +1$, $R_{L, dm} = 1\text{ k}\Omega$, unless otherwise noted. All specifications refer to single-ended input and differential outputs, unless otherwise noted.

Table 1.

Parameter	Conditions	Min	Typ	Max	Unit
$\pm D_{IN}$ TO $\pm OUT$ PERFORMANCE					
DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	$V_{OUT} = 0.5\text{ V p-p}$, Differential Input		1600		MHz
Bandwidth for 0.1 dB Flatness	$V_{OUT} = 2\text{ V p-p}$, Differential Input		125		MHz
Large Signal Bandwidth	$V_{OUT} = 2\text{ V p-p}$, Differential Input		1400		MHz
	$V_{OUT} = 4\text{ V p-p}$, Differential Input		500		MHz
Slew Rate	$V_{OUT} = 2\text{ V p-p}$		5000		V/ μs
Settling Time	0.01%, $V_{OUT} = 2\text{ V p-p}$		8		ns
Overdrive Recovery Time	$V_{IN} = 2.5\text{ V}$ to 0 V step, $G = +2$		4		ns
NOISE/HARMONIC PERFORMANCE ¹					
Second Harmonic	$V_{OUT} = 2\text{ V p-p}$, 10 MHz		-121		dBc
	$V_{OUT} = 2\text{ V p-p}$, 70 MHz		-81		dBc
	$V_{OUT} = 2\text{ V p-p}$, 100 MHz		-72		dBc
Third Harmonic	$V_{OUT} = 2\text{ V p-p}$, 10 MHz		-100		dBc
	$V_{OUT} = 2\text{ V p-p}$, 70 MHz		-86		dBc
	$V_{OUT} = 2\text{ V p-p}$, 100 MHz		-81		dBc
IMD	70 MHz				dBc
IP3	70 MHz				dBm
Voltage Noise (RTI)			2.2		nV/ $\sqrt{\text{Hz}}$
Noise Figure	$G = +2$		12		dB
Input Current Noise			3		pA/ $\sqrt{\text{Hz}}$
INPUT CHARACTERISTICS					
Offset Voltage	$V_{OS, dm} = V_{OUT, dm}/2$; $V_{DIN+} = V_{DIN-} = 2.5\text{ V}$ T_{MIN} to T_{MAX} variation		1 ± 4		mV $\mu\text{V}/^\circ\text{C}$
Input Bias Current	T_{MIN} to T_{MAX} variation	-50	-17		μA
Input Resistance	Differential		6		M Ω
	Common mode		3		M Ω
Input Capacitance			1		pF
Input Common-Mode Voltage			0.3 to 3.0		V
CMRR	$\Delta V_{OUT, dm}/\Delta V_{IN, cm}$; $\Delta V_{IN, cm} = \pm 1\text{ V}$		-72		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	Maximum ΔV_{OUT} ; single-ended output	1		4	V
Output Current			95		mA
Output Balance Error	$\Delta V_{OUT, cm}/\Delta V_{OUT, dm}$; $\Delta V_{OUT, dm} = 1\text{ V}$; 10 MHz		-56		dB
V_{OCM} to $\pm OUT$ PERFORMANCE					
V_{OCM} DYNAMIC PERFORMANCE					
-3 dB Bandwidth			250		MHz
Slew Rate			1300		V/ μs
INPUT VOLTAGE NOISE (RTI)					
V_{OCM} INPUT CHARACTERISTICS					
Input Voltage Range		1.2		3.8	V
Input Resistance			10		k Ω
Input Offset Voltage	$V_{OS, cm} = V_{OUT, cm}$; $V_{DIN+} = V_{DIN-} = 2.5\text{ V}$		1	3.5	mV
Input Bias Current			0.5		μA
V_{OCM} CMRR	$\Delta V_{OUT, dm}/\Delta V_{OCM}$; $\Delta V_{OCM} = \pm 1\text{ V}$		-75		dB

Parameter	Conditions	Min	Typ	Max	Unit
Gain	$\Delta V_{OUT,cm}/\Delta V_{OCM}; \Delta V_{OCM} = \pm 1\text{ V}$		1		V/V
POWER SUPPLY					
Operating Range		3		5.5	V
Quiescent Current	T_{MIN} to T_{MAX} variation		36		mA
	Powered down		25		$\mu\text{A}/^\circ\text{C}$
Power Supply Rejection Ratio	$\Delta V_{OUT,dm}/\Delta V_S; \Delta V_S = \pm 1\text{ V}$		< 0.2		mA
			-90		dB
POWER DOWN (PD)					
$\overline{\text{PD}}$ Input Voltage	Powered down		≤ 1		V
	Enabled		≥ 2		V
Turn-Off Time			1		μs
Turn-On Time			200		ns
$\overline{\text{PD}}$ Bias Current					
Enabled	$\overline{\text{PD}} = 5\text{ V}$		40		μA
Disabled	$\overline{\text{PD}} = 0\text{ V}$		200		μA
OPERATING TEMPERATURE RANGE		-40		+105	$^\circ\text{C}$

3.3 V OPERATION

At 25°C, +V_S = 3.3 V, -V_S = 0 V, V_{OCM} = 1.5 V, R_G = R_F = 200 Ω, G = +1, R_{L, dm} = 1 kΩ, unless otherwise noted. All specifications refer to single-ended input and differential outputs, unless otherwise noted.

Table 2.

Parameter	Conditions	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
-3 dB Small Signal Bandwidth	V _{OUT} = 0.5 V p-p, Differential Input		1600		MHz
Bandwidth for 0.1 dB Flatness	V _{OUT} = 1 V p-p, Differential Input		125		MHz
Large Signal Bandwidth	V _{OUT} = 1 V p-p, Differential Input		1000		MHz
Slew Rate	V _{OUT} = 1 V p-p		3300		V/μs
Settling Time	0.01%, V _{OUT} = 1 Vp-p		8		ns
Overdrive Recovery Time	V _{IN} = 1.65 V to 0 V step, G = +2		4		ns
NOISE/HARMONIC PERFORMANCE¹					
Second Harmonic	V _{OUT} = 1 V p-p, 10 MHz		-106		dBc
	V _{OUT} = 1 V p-p, 70 MHz		-88		dBc
	V _{OUT} = 1 V p-p, 100 MHz		-81		dBc
Third Harmonic	V _{OUT} = 1 V p-p, 10 MHz		-93		dBc
	V _{OUT} = 1 V p-p, 70 MHz		-80		dBc
	V _{OUT} = 1 V p-p, 100 MHz		-71		dBc
IMD	70 MHz				dBc
IP3	70 MHz				dBm
Voltage Noise (RTI)			2.2		nV/√Hz
Noise Figure	G = +2		12		dB
Input Current Noise			3		pA/√Hz
INPUT CHARACTERISTICS					
Offset Voltage	V _{OS, dm} = V _{OUT, dm} /2; V _{DIN+} = V _{DIN-} = 1.5 V T _{MIN} to T _{MAX} variation		1 ±4		mV μV/°C
Input Bias Current	T _{MIN} to T _{MAX} variation	-50	-17		μA
Input Resistance	Differential		-0.01		μA/°C
	Common mode		6		MΩ
Input Capacitance			3		MΩ
Input Common-Mode Voltage			1		pF
CMRR	ΔV _{OUT, dm} /ΔV _{IN, cm} ; ΔV _{IN, cm} = ±1 V		0.3 to 1.2		V
			-72		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	Maximum ΔV _{OUT} ; single-ended output	1.1		1.9	V
Output Current			95		mA
Output Balance Error	ΔV _{OUT, cm} /ΔV _{OUT, dm} ; ΔV _{OUT, dm} = 1 V		-56		dB
V_{OCM} to ±OUT PERFORMANCE					
V_{OCM} DYNAMIC PERFORMANCE					
-3 dB Bandwidth			250		MHz
Slew Rate	V = 0.5 V		1300		V/μs
INPUT VOLTAGE NOISE (RTI)					
			7.5		nV/√Hz
V_{OCM} INPUT CHARACTERISTICS					
Input Voltage Range		1.2		2.1	V
Input Resistance			10		kΩ
Input Offset Voltage	V _{OS, cm} = V _{OUT, cm} ; V _{DIN+} = V _{DIN-} = 1.5 V		1	3.5	mV
Input Bias Current			0.5		μA
V _{OCM} CMRR	ΔV _{OUT, dm} /ΔV _{OCM} ; ΔV _{OCM} = ±1 V		-75		dB
Gain	ΔV _{OUT, cm} /ΔV _{OCM} ; ΔV _{OCM} = ±1 V		1		V/V
POWER SUPPLY					
Operating Range		3		5.5	V
Quiescent Current			33		mA

Parameter	Conditions	Min	Typ	Max	Unit
Power Supply Rejection Ratio	T_{MIN} to T_{MAX} variation		25		$\mu A/^{\circ}C$
	Powered down		< 0.2		mA
	$\Delta V_{OUT, dm} / \Delta V_S$; $\Delta V_S = \pm 1 V$		-90		dB
POWER DOWN (\overline{PD})					
\overline{PD} Input Voltage	Powered down		≤ 1		V
Turn-Off Time	Enabled		≥ 2		V
Turn-On Time			1		μs
\overline{PD} Bias Current			200		ns
Enabled	$\overline{PD} = 3.3 V$		20		μA
Disabled	$\overline{PD} = 0 V$		-120		μA
OPERATING TEMPERATURE RANGE		-40		+105	$^{\circ}C$

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
Supply Voltage	TBD
Power Dissipation	See Figure 2
Storage Temperature Range	-65°C to +125°C
Operating Temperature Range	-40°C to +105°C
Lead Temperature (Soldering, 10 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Rating may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions; that is, θ_{JA} is specified for a device (including exposed pad) soldered to the circuit board.

Table 4. Thermal Resistance

Package Type	θ_{JA}	Unit
16-Lead LFCSP (Exposed Pad)	TBD	°C/W

Maximum Power Dissipation

The maximum safe power dissipation in the ADA4937-1 package is limited by the associated rise in junction temperature (T_j) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance of the ADA4937-1. Exceeding a junction temperature of 150°C for an extended period can result in changes in the silicon devices, potentially causing failure.

The power dissipated in the package (P_D) is the sum of the quiescent power dissipation and the power dissipated in the package due to the load drive. The quiescent power is the voltage between the supply pins (V_S) times the quiescent current (I_S). The power dissipated due to the load drive depends upon the particular application. The power due to load drive is calculated by multiplying the load current by the associated voltage drop across the device. RMS voltages and currents must be used in these calculations.

Airflow increases heat dissipation, effectively reducing θ_{JA} . In addition, more metal directly in contact with the package leads/exposed pad from metal traces, through-holes, ground, and power planes reduces the θ_{JA} .

Figure 2 shows the maximum safe power dissipation in the package vs. the ambient temperature for the 16-lead LFCSP (TBD °C/W) on a JEDEC standard 4-layer board.

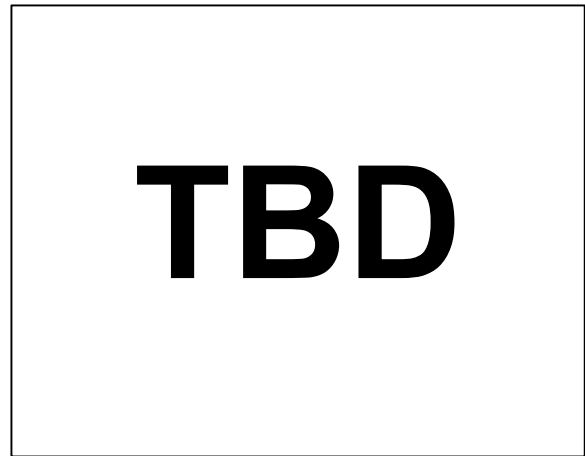


Figure 2. Maximum Power Dissipation vs. Temperature for a 4-Layer Board

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

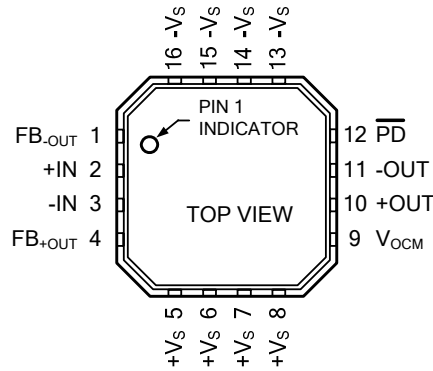


Figure 3. Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	FB _{-OUT}	Negative output feedback pin
2	+IN	Positive input summing node
3	-IN	Negative input summing node
4	FB _{+OUT}	Positive output feedback pin
5 to 8	+V _S	Positive supply voltage
9	V _{OCM}	Output common mode voltage
10	+OUT	Positive output
11	-OUT	Negative output
12	PD	Power-down pin
13 to 16	-V _S	Negative supply voltage

